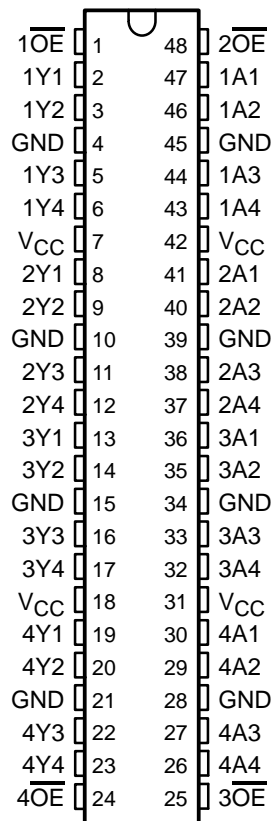


SN54ABTH16244, SN74ABTH16244 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCBS677A – SEPTEMBER 1996 – REVISED OCTOBER 1996

- Members of the Texas Instruments *Widebus*™ Family
- State-of-the-Art *EPIC-II B*™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I_{OH} , 64-mA I_{OL})
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ($C = 200$ pF, $R = 0$)
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

SN54ABTH16244 . . . WD PACKAGE
SN74ABTH16244 . . . DGG OR DL PACKAGE
(TOP VIEW)



description

The 'ABTH16244 are 16-bit buffers and line drivers designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. These devices provide true outputs and symmetrical active-low output-enable (\overline{OE}) inputs.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABTH16244 is available in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed circuit board area.

The SN54ABTH16244 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABTH16244 is characterized for operation from -40°C to 85°C .

FUNCTION TABLE
(each buffer)

| INPUTS | | OUTPUT Y |
|-----------------|---|-------------|
| \overline{OE} | A | |
| L | H | H |
| L | L | L |
| H | X | Z |



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**TEXAS
INSTRUMENTS**

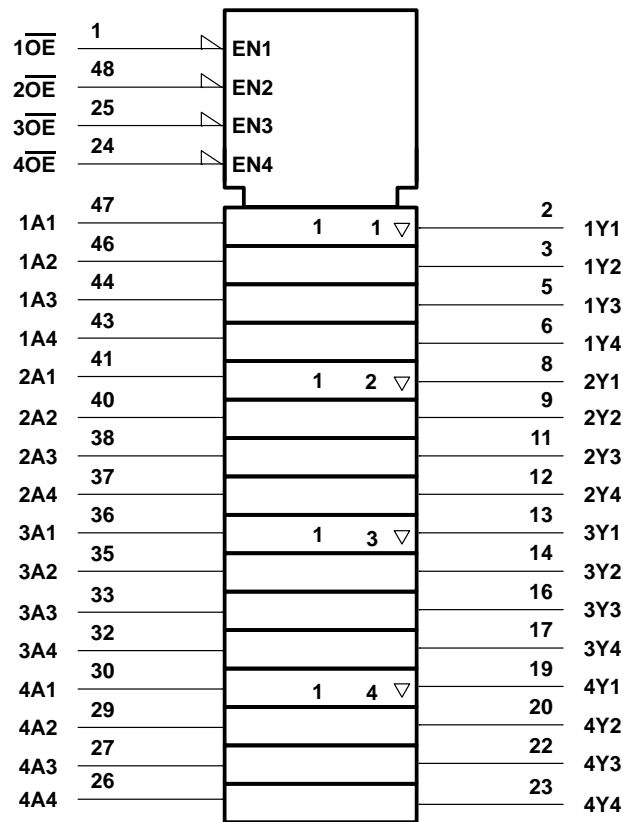
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

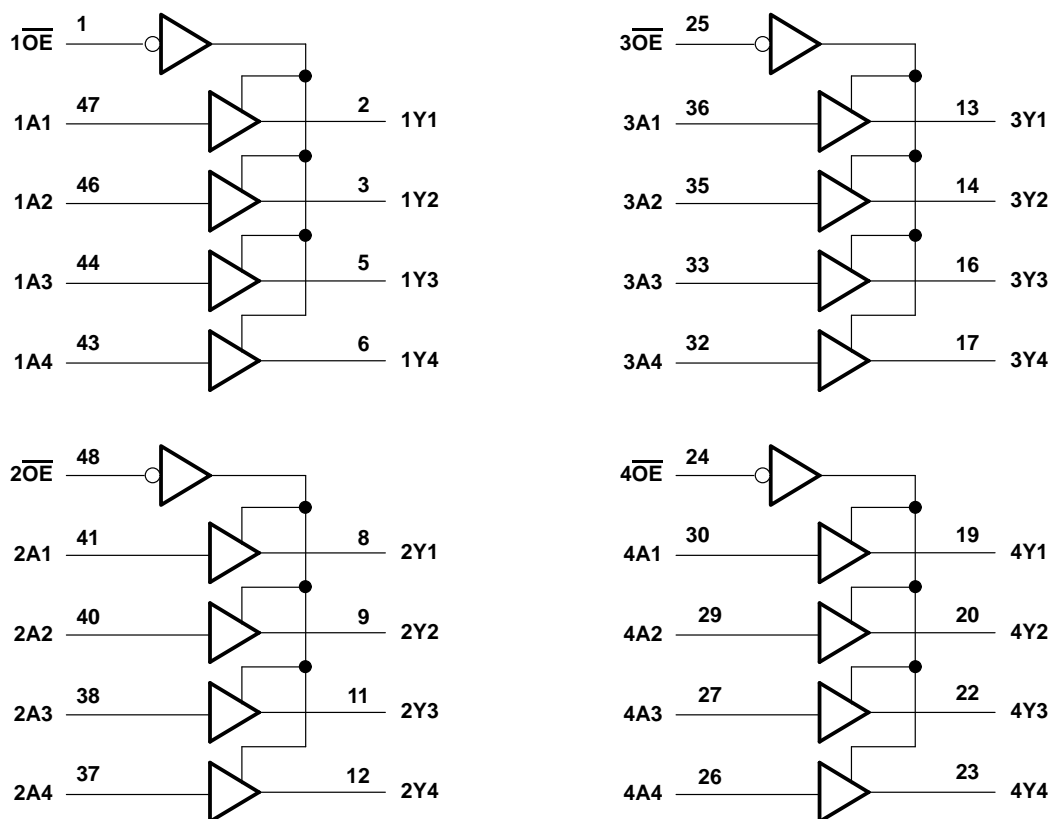
SN54ABTH16244, SN74ABTH16244

16-BIT BUFFERS/DRIVERS

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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

| | |
|--|-----------------|
| Supply voltage range, V_{CC} | –0.5 V to 7 V |
| Input voltage range, V_I (see Note 1) | –0.5 V to 7 V |
| Voltage range applied to any output in the high state or power-off state, V_O | –0.5 V to 5.5 V |
| Current into any output in the low state, I_O : SN54ABTH16244 | 96 mA |
| SN74ABTH16244 | 128 mA |
| Input clamp current, I_{IK} ($V_I < 0$) | –18 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | –50 mA |
| Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DGG package | 0.85 W |
| DL package | 1.2 W |
| Storage temperature range, T_{stg} | –65°C to 150°C |

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the *ABT Advanced BiCMOS Technology Data Book*.

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16-BIT BUFFERS/DRIVERS

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recommended operating conditions (see Note 3)

| | | | SN54ABTH16244 | | SN74ABTH16244 | | UNIT |
|---------------------|------------------------------------|-----------------|---------------|----------|---------------|----------|------|
| | | | MIN | MAX | MIN | MAX | |
| V_{CC} | Supply voltage | | 4.5 | 5.5 | 4.5 | 5.5 | V |
| V_{IH} | High-level input voltage | | 2 | | 2 | | V |
| V_{IL} | Low-level input voltage | | | 0.8 | | 0.8 | V |
| V_I | Input voltage | | 0 | V_{CC} | 0 | V_{CC} | V |
| I_{OH} | High-level output current | | | –24 | | –32 | mA |
| I_{OL} | Low-level output current | | | 48 | | 64 | mA |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | Outputs enabled | | 10 | | 10 | ns/V |
| T_A | Operating free-air temperature | | –55 | 125 | –40 | 85 | °C |

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | | $T_A = 25^\circ\text{C}$ | | | SN54ABTH16244 | | SN74ABTH16244 | | UNIT |
|--------------------|--|--------------------------|--------------------------|------|-----------|---------------|---------|---------------|-----------|---------------|
| | | | MIN | TYP† | MAX | MIN | MAX | MIN | MAX | |
| V_{IK} | $V_{CC} = 4.5\text{ V}$, $I_I = -18\text{ mA}$ | | | | –1.2 | | –1.2 | | –1.2 | V |
| V_{OH} | $V_{CC} = 4.5\text{ V}$, $I_{OH} = -3\text{ mA}$ | | 2.5 | | | 2.5 | | 2.5 | | V |
| | $V_{CC} = 5\text{ V}$, $I_{OH} = -3\text{ mA}$ | | 3 | | | 3 | | 3 | | |
| | $V_{CC} = 4.5\text{ V}$ | $I_{OH} = -24\text{ mA}$ | 2 | | | 2 | | | | |
| | | $I_{OH} = -32\text{ mA}$ | 2* | | | | | 2 | | |
| V_{OL} | $V_{CC} = 4.5\text{ V}$ | | | | 0.55 | | 0.55 | | | V |
| | | | | | 0.55* | | | | 0.55 | |
| I_I | $V_{CC} = 5.5\text{ V}$, $V_I = V_{CC}$ or GND | | | | ± 1 | | ± 1 | | ± 1 | μA |
| $I_I(\text{hold})$ | $V_{CC} = 4.5\text{ V}$ | | | | 100 | | 100 | | 100 | μA |
| | | | | | –40 | | –40 | | –40 | |
| I_{OZH} | $V_{CC} = 5.5\text{ V}$, $V_O = 2.7\text{ V}$ | | | | 10 | | 10 | | 10 | μA |
| I_{OZL} | $V_{CC} = 5.5\text{ V}$, $V_O = 0.5\text{ V}$ | | | | –10 | | –10 | | –10 | μA |
| I_{off} | $V_{CC} = 0$, V_I or $V_O \leq 4.5\text{ V}$ | | | | ± 100 | | | | ± 100 | μA |
| I_{CEX} | $V_{CC} = 5.5\text{ V}$, $V_O = 5.5\text{ V}$ | Outputs high | | | 50 | | 50 | | 50 | μA |
| $I_{O\ddagger}$ | $V_{CC} = 5.5\text{ V}$, $V_O = 2.5\text{ V}$ | | –50 | –100 | –180 | –50 | –180 | –50 | –180 | mA |
| I_{CC} | $V_{CC} = 5.5\text{ V}$, $I_O = 0$, $V_I = V_{CC}$ or GND | | | | 3 | | 2 | | 3 | mA |
| | | | | | 32 | | 32 | | 32 | |
| | | | | | 3 | | 2 | | 3 | |
| $\Delta I_{CC}\S$ | $V_{CC} = 5.5\text{ V}$, One input at 3.4 V, Other inputs at V_{CC} or GND | | | | 1.5 | | 1.5 | | 1.5 | mA |
| C_i | $V_I = 2.5\text{ V}$ or 0.5 V | | | | 3 | | | | | pF |
| C_o | $V_O = 2.5\text{ V}$ or 0.5 V | | | | 8 | | | | | pF |

* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at $V_{CC} = 5\text{ V}$.

‡ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$ | | | SN54ABTH16244 | | SN74ABTH16244 | | UNIT |
|-----------|-----------------|----------------|---|-----|-----|---------------|-----|---------------|-----|------|
| | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t_{PLH} | A | Y | 1 | 2.3 | 3.2 | 0.7 | 3.7 | 1 | 3.5 | ns |
| t_{PHL} | | | 1 | 2.6 | 3.7 | 0.5 | 4.3 | 1 | 4.1 | |
| t_{PZH} | \overline{OE} | Y | 1 | 3 | 3.8 | 0.7 | 5 | 1 | 4.8 | ns |
| t_{PZL} | | | 1 | 3.2 | 4 | 0.9 | 5 | 1 | 4.8 | |
| t_{PHZ} | \overline{OE} | Y | 1 | 3.6 | 4.4 | 1 | 5 | 1 | 4.8 | ns |
| t_{PLZ} | | | 1 | 2.9 | 3.7 | 1 | 4.3 | 1 | 4.1 | |

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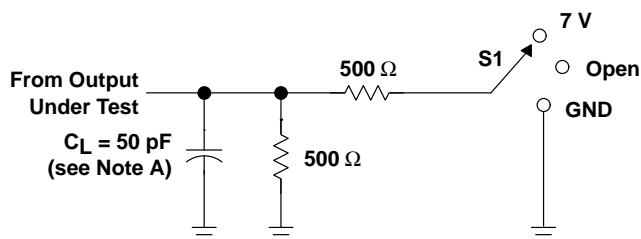
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16-BIT BUFFERS/DRIVERS

WITH 3-STATE OUTPUTS

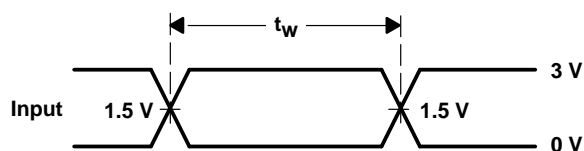
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PARAMETER MEASUREMENT INFORMATION

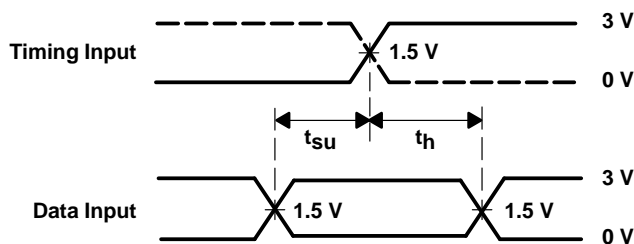


LOAD CIRCUIT

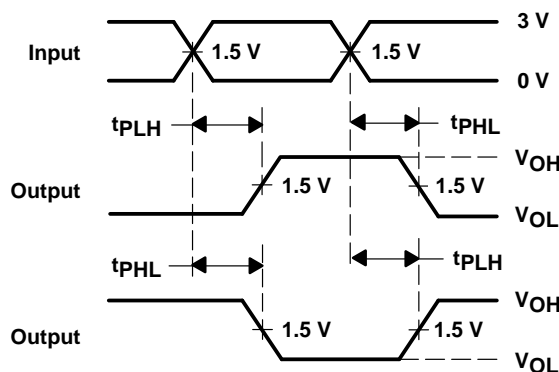
| TEST | S1 |
|-------------------|------|
| t_{PLH}/t_{PHL} | Open |
| t_{PLZ}/t_{PZL} | 7 V |
| t_{PHZ}/t_{PZH} | Open |



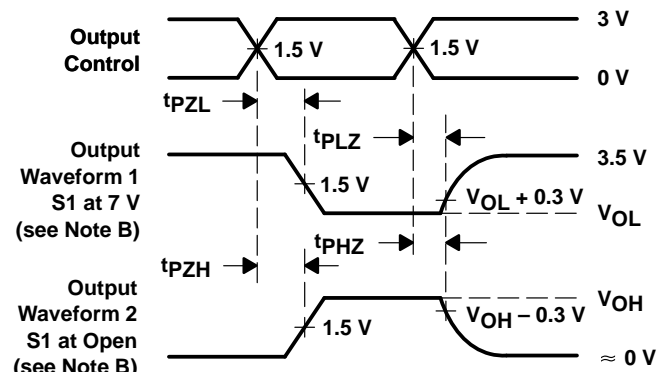
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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